

1           1.    A method comprising:  
2                coupling a first and second surface of an  
3   electronic device; and  
4                injecting an encapsulant between said first and  
5   second surfaces through one of said surfaces.

1           2.    The method of claim 1 wherein injecting an  
2   encapsulant includes forming a hole through one of said  
3   surfaces and injecting encapsulant through said hole.

1           3.    The method of claim 2 including forming a  
2   centrally located hole and forming a plurality of radially  
3   displaced holes arranged at a substantially uniform radius  
4   from said centrally located hole.

1           4.    The method of claim 3 including injecting  
2   encapsulant through said centrally located hole until the  
3   encapsulant reaches said radially displaced holes and  
4   thereafter stopping the injection of encapsulant through  
5   said centrally located hole and injecting encapsulant  
6   through said radially displaced holes.

1           5.    The method of claim 1 wherein injecting an  
2   encapsulant includes causing an encapsulant front to extend  
3   outwardly from the center of a region to be encapsulated  
4   between said first and second surfaces.

1           6.    The method of claim 5 including injecting  
2 encapsulant through a central hole through one of said  
3 surfaces.

1           7.    The method of claim 6 including terminating the  
2 injection of encapsulant through said central hole and  
3 injecting encapsulant through a plurality of holes  
4 substantially uniformly radially displaced with respect to  
5 said central hole.

1           8.    The method of claim 7 including stopping the  
2 injection of said encapsulant through radially displaced  
3 holes and initiating the injection of encapsulant through a  
4 second set of holes radially displaced with respect to said  
5 radially displaced holes.

1           9.    The method of claim 1 including forming an  
2 electronic display.

1           10.   The method of claim 1 including injecting  
2 encapsulant into the region between a pair of spaced  
3 plates.

1           11.   An electronic device comprising:  
2               a first surface;

3           a second surface spaced from said first surface,  
4   said second surface including at least one encapsulation  
5   injection port extending through said surface; and  
6           encapsulation between said first and second  
7   surfaces.

1       12. The device of claim 11 wherein said device is a  
2   display.

1       13. The device of claim 11 wherein one of said  
2   surfaces is a glass panel.

1       14. The device of claim 11 wherein said surfaces are  
2   surface mounted to one another.

1       15. The device of claim 11 wherein said device is an  
2   organic light emitting display device.

1       16. The device of claim 11 including a plurality of  
2   encapsulation injection ports extending through said first  
3   surface.

1       17. The device of claim 16 including a centrally  
2   located injection port, and a first array of substantially  
3   uniformly radially displaced injection ports positioned

4 radially outwardly of said centrally located injection  
5 port.

1 18. The device of claim 17 including a second array  
2 of substantially uniformly displaced injection ports  
3 positioned radially outwardly with respect to said first  
4 array.

1 19. A method comprising:  
2 injecting encapsulant into an electronic device  
3 at a first location; and  
4 when the encapsulant reaches a second location  
5 spaced from said first location, injecting encapsulant at a  
6 location proximate to said second location.

1 20. The method of claim 19 including coupling a first  
2 and second surface of an electronic device and injecting  
3 encapsulant between said first and second surfaces.

1 21. The method of claim 20 including forming a  
2 centrally located hole and forming a plurality of radially  
3 displaced holes arranged at a substantially uniform radius  
4 from said centrally located hole.

1        22. The method of claim 21 including injecting  
2 encapsulant through said centrally located hole until the  
3 encapsulant reaches said radially displaced holes and  
4 thereafter stopping the injection of encapsulant through  
5 said centrally located hole and injecting encapsulant  
6 through said radially displaced holes.

1        23. The method of claim 19 including forming an  
2 electronic display.

1        24. The method of claim 19 including injecting  
2 encapsulant into a region between a pair of spaced plates.

1        25. The method of claim 24 including injecting  
2 encapsulant through one of said plates.